

### 1 Characteristics

Table 1. Absolute maximum ratings (limiting values),  $T_j$  = 25 °C unless otherwise specified

Symbol	Parameter	Value	Unit
I <sub>TRM</sub>	Repetitive peak on-state current, t <sub>p</sub> = 20 μs, F = 120 Hz	2.00	Α
T <sub>stg</sub>	Storage junction temperature range -40 to +129		°C
Tj	Operating junction temperature range	-40 to +125	°C

Table 2. Electrical characteristics ( $T_j$  = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions		Value	Unit
			Min.	30	
V <sub>BO</sub>	Breakover voltage (1)	C = 10 nF <sup>(2)</sup>	Тур.	32	V
			Max.	34	
I V <sub>BO1</sub> - V <sub>BO2</sub> I	Breakover voltage symmetry	C = 10 nF (2)	Max.	2	V
Δ٧	Dynamic breakover voltage (1)	V <sub>BO</sub> and V <sub>F</sub> at 10 mA	Min.	9	V
Vo	Output voltage (1)	See Figure 2. Test circuit, (R = 20 Ω)	Min.	5	V
I <sub>BO</sub>	Breakover current (1)	C = 10 nF (2)	Max.	15	μA
t <sub>r</sub>	Rise time (1)	See Figure 3. Rise time measurement	Max.	2	μs
I <sub>R</sub>	Leakage current (1)	V <sub>R</sub> = 0.5 x V <sub>BO</sub> max	Max.	10	μA
I <sub>P</sub>	Peak current (1)	See Figure 2. Test circuit	Min.	0.30	Α

<sup>1.</sup> Applicable to both forward and reverse directions.

DS2137 - Rev 3 page 2/9

<sup>2.</sup> Connected in parallel to the device



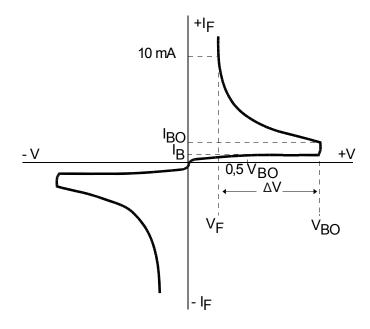
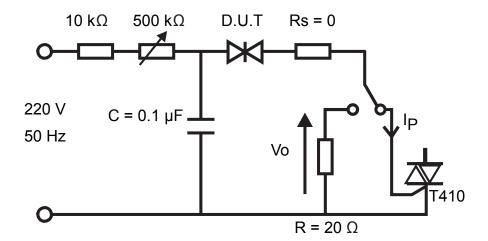
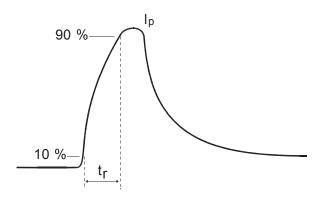


Figure 2. Test circuit



DS2137 - Rev 3 page 3/9







### 1.1 Characteristics (curves)

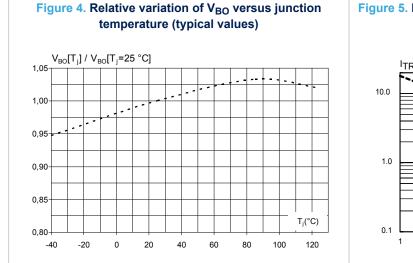


Figure 5. Peak on-state current versus Triac gate current pulse duration t<sub>p</sub>

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

10.0

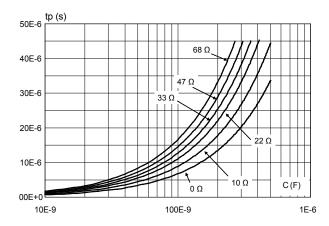
10.0

10.0

10.0

10.0

Figure 6. Triac gate current pulse duration  $t_p$  (to have  $I_P > 50$  mA) versus Rs and C values (typical values)



Note: according to Figure 2. Test circuit

DS2137 - Rev 3 page 5/9



## Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK is an ST trademark.

### 2.1 DO-35 package information

Figure 7. DO-35 package outline

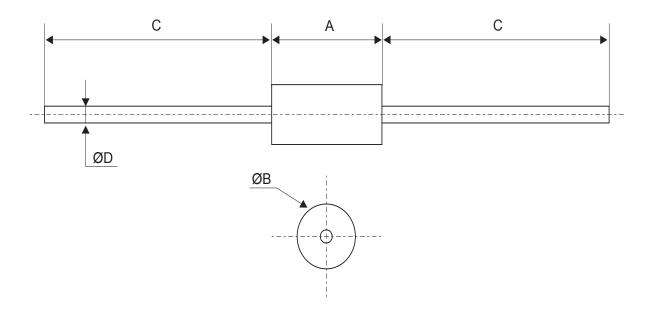


Table 3. DO-35 package mechanical data

	Dimensions				
Ref. Millime		neters	Inch	es <sup>(1)</sup>	
	Min.	Max.	Min.	Max.	
A	3.05	4.50	0.120	0.177	
В	1.53	2	0.060	0.079	
С	28	31	1.102	1.220	
D	0.46	0.55	0.018	0.022	

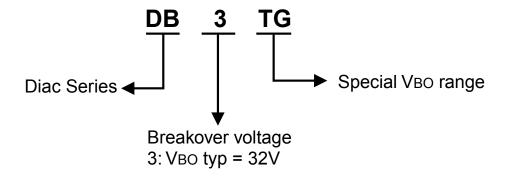
1. Inches given for reference only

DS2137 - Rev 3 page 6/9



# 3 Ordering information

Figure 8. Ordering information scheme



**Table 4. Ordering information** 

Order code	de Marking Package Weight		Base qty.	Delivery mode	
DB3TG	DB3TG (Blue Body Coat)	DO-35	0.15 g	5000	Tape and reel

DS2137 - Rev 3 page 7/9



## **Revision history**

Table 5. Document revision history

Date	Version	Changes		
Oct-2001	2	Previous release.		
07-May-2019 3		Updated Section 1.1 Characteristics (curves).		



#### **IMPORTANT NOTICE - PLEASE READ CAREFULLY**

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. For additional information about ST trademarks, please refer to <a href="https://www.st.com/trademarks">www.st.com/trademarks</a>. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2019 STMicroelectronics - All rights reserved

DS2137 - Rev 3 page 9/9